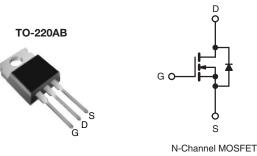


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	600			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	1.2		
Q _g (Max.) (nC)	39			
Q _{gs} (nC)	10			
Q _{gd} (nC)	19			
Configuration	Single			



FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V, V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Extremely High Frequency Operation
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional Power MOSFETs. Utilizing the new LCDMOS technology, the device improvements are achieved without added product cost, allowing for reduced gate drive requirements and total system savings. In addition reduced switching losses and improved efficiency are achievable in a variety of high frequency applications. Frequencies of a few MHz at high current are possible using the new low charge Power MOSFETs.

These device improvements combined with the proven ruggedness and reliability that are characteristic of Power MOSFETs offer the designer a new standard in power transistors for switching applications.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBC40LCPbF
	SiHFBC40LC-E3
SnPb	IRFBC40LC
	SiHFBC40LC

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	600	V	
Gate-Source Voltage		V _{GS}	± 30	V	
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 \degree C$	- I _D -	6.2	А	
	V_{GS} at 10 V $T_C = 100 ^{\circ}C$		3.9		
Pulsed Drain Current ^a	I _{DM}	25			
Linear Derating Factor			1.0	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	530	mJ	
Repetitive Avalanche Current ^a		I _{AR} 6.2		А	
Repetitive Avalanche Energy ^a		E _{AR}	13	mJ	
Maximum Power Dissipation	T _C = 25 °C	PD	125	W	
Peak Diode Recovery dV/dtc		dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s	Ŭ.	300 ^d		
Mounting Torque	6.20 or M2 corow		10	lbf ∙ in	
	6-32 or M3 screw		1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 25 mH, $R_g = 25 \Omega$, $I_{AS} = 6.2 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq 6.2$ A, dl/dt ≤ 80 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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RoHS

COMPLIANT

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PARAMETER	SYI	MBOL	TYP.	MAX.		UNIT		
Maximum Junction-to-Ambient	F	thJA	-	62				
Case-to-Sink, Flat, Greased Surface	R	thCS	0.50	-	-		°C/W	
Maximum Junction-to-Case (Drain)	F	thJC	-	1.0				
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = 250 μA	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20$		-	-	± 100	nA	
Zara Cata Valtaga Drain Current	1	V _{DS} =	600 V, V _{GS} = 0 V	-	-	100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V,	$V_{GS} = 0 V, T_{J} = 125$	°C -	-	500	ρ μΑ	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 3.7 A ^b	-	-	1.2	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 1$	100 V, I _D = 3.7 A ^b	3.7	-	-	S	
Dynamic					•	•		
Input Capacitance	C _{iss}	$V_{GS} = 0 V$ $V_{DS} = 25 V$ f = 1.0 MHz, see fig. 5		-	1100	-	pF	
Output Capacitance	C _{oss}			-	140	-		
Reverse Transfer Capacitance	C _{rss}			-	15	-		
Total Gate Charge	Qg			-	-	39	nC	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 6.2 \text{ A}, V_{DS} = 360 \text{ V},$		-	10		
Gate-Drain Charge	Q _{gd}	-	see fig. 6 and 13 ^b		-	19	1	
Turn-On Delay Time	t _{d(on)}		•	-	12	-		
Rise Time	t _r	$V_{DD} = 300 \text{ V}, \text{ I}_D = 6.2 \text{ A}$ $\text{R}_\text{g} = 9.1 \ \Omega, \text{ R}_\text{D} = 47 \ \Omega, \text{ see fig. } 10^\text{b}$		-	20	-	- ns	
Turn-Off Delay Time	t _{d(off)}			0 ^b -	27	-		
Fall Time	t _f			-	17	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		- -	4.5	-	nH	
Internal Source Inductance	Ls			-	7.5	-		
Drain-Source Body Diode Characteristic	s	•			1			
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.2	- A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	25		
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^\circ C, \ I_S = 6.2 \ A, \ V_{GS} = 0 \ V^b$		^{ıb} –	-	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 6.2 A, dl/dt = 100 A/μs ^b		- /ue ^b	440	680	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			νµs- -	2.1	3.2	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-o			minated k	مر مر	1	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

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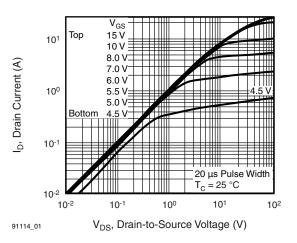


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

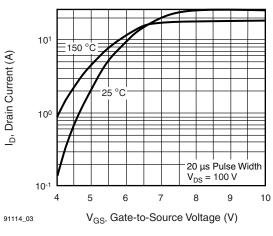


Fig. 3 - Typical Transfer Characteristics

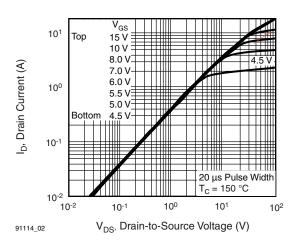


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

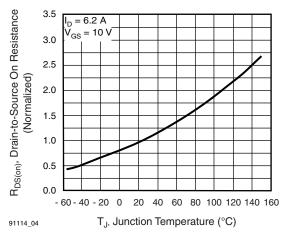


Fig. 4 - Normalized On-Resistance vs. Temperature

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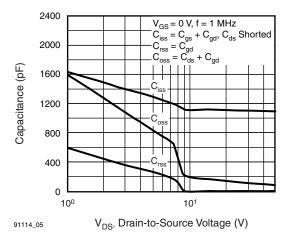


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

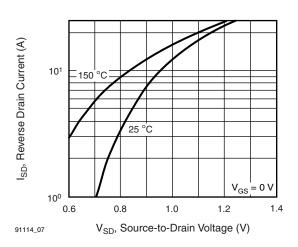


Fig. 7 - Typical Source-Drain Diode Forward Voltage

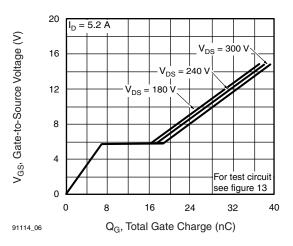


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

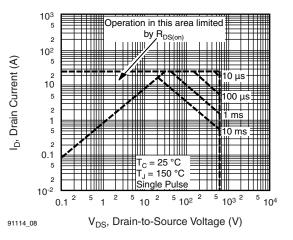


Fig. 8 - Maximum Safe Operating Area

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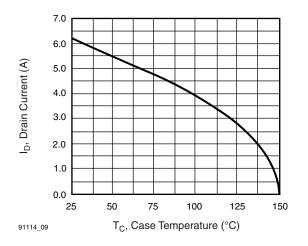


Fig. 9 - Maximum Drain Current vs. Case Temperature

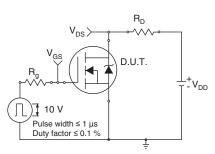


Fig. 10a - Switching Time Test Circuit

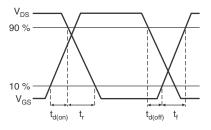


Fig. 10b - Switching Time Waveforms

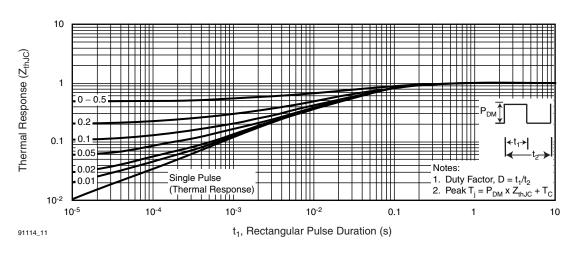


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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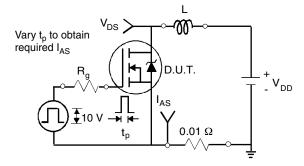


Fig. 12a - Unclamped Inductive Test Circuit

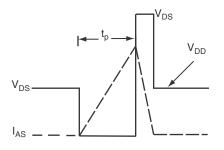


Fig. 12b - Unclamped Inductive Waveforms

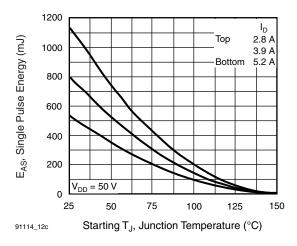
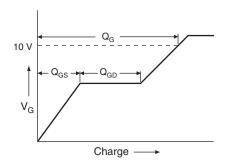
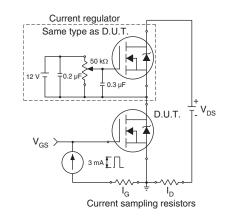


Fig. 12c - Maximum Avalanche Energy vs. Drain Current







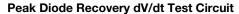


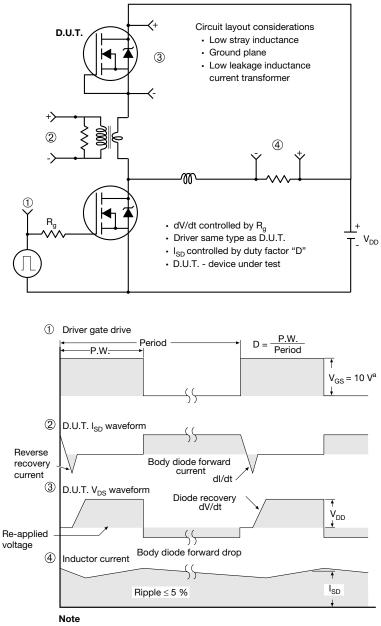
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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